The Role of Cathode's Surface Properties in the Electrochemical Deuterium Loading of Pd Foils

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INTRODUCTION

Experimental Results

correlation between excess heat and cathode surface properties

- Morphology (PSD), crystal orientation, impurities

Theoretical hints

Theoretical frames suggest electro-dynamical effects (plasmons excitation) to be involved in excess heat production

Local em field in-homogeneities affect electrochemical kinetics and metal/electrolyte interface reconstruction



OUTLINE

Role of surface in PdH electrodinamics

- em field enhancement (plasmon excitation)
 - Morphology



– **Dielectric costant** E. Castagna S10_O4

Effects on Electro-chemical kinetics interplay between kinetic parameters and surface morphology



Role of surface morphology in electric field enhancement

the em field can be enhanced close to a metal-dielectric interface via the excitation of surface plasmons (SP, collective oscillation modes of the free electrons)

Surface roughness and isolated features make it possible the coupling of the em. field source with the SP modes, because **they provide** <u>additional wavevector</u> to the source em field to fulfill the required momentum conservation



It is the wave-vector "content" of the surface morphology (i.e. the Power Spectrum) that play the role in the SP interaction.



Theoretical Approach to EM Field Enhancement Calculations

- The rigorous calculation of the electric field enhancement produced by a *real* surface profile is a very complicate task, that needs a model for the surface profile.
- Some particular ideal cases have been studied, from which physical insight can be extracted:
- 1) periodic gratings
- 2) moderately rough random surface profiles
- 3) isolated sub-wavelength particles
- 4) completely disordered patterns (Anderson-like)
- 5) fractal percolating aggregates



What does our sample surface look like more?

Not –engineered Pd foils, prepared by cold rolling, thermal annealing, acid etching and undergone to electrochemical D (H) loading





Microscopy images (AFM,SEM):

moderately rough random surfaces







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Theory [1] :

The surface profile $\zeta(x,y)$ is described as the **superposition** of several **sinusoidal diffraction gratings**:

$$z = \zeta(x, y) = \sum_{\vec{G}} \zeta_G e^{i\vec{G}\cdot\vec{R}}$$

where R is the spatial coordinate (x,y) and the $\langle \zeta(x,y) \rangle = 0$

- To <u>first order theory in ζ/λ </u>, the scattering of an em wave from the surface $\zeta(x,y)$ is reduced to the superposition of the scatterings from single sinusoidal diffraction gratings, each characterized by an amplitude ζ_G
- SP excitation by light in a sinusoidal grating with wave-vector G is allowed if the following matching conditions if satisfied:

$$G = K_{sp} - K_{inc}$$
(1)
$$K_{sp} = (2\pi/\lambda)^2 \operatorname{Real}(\varepsilon_m / (\varepsilon_m + \varepsilon_d))$$
(2)

where K_{inc} is the projection of the incident wave-vector into the XY plane, ε_m is the metal dielectric constant and ε_d is the dielectric constant of the adjacent medium

^[1]A. Marvin, F. Toigo, V. Celli, Phys. Rev. B 11, 2777 (1975)



SP excitation probability

It results that the SP excitation probability (ΔR_{sp})

 $\Delta R_{sp} = (2\pi/\lambda)^4 \cos(\theta_{inc}) \int PSD(\mathbf{G}) \operatorname{factor}(\mathbf{G}, \theta_{inc}, \varepsilon_m, \varepsilon_d) \,\delta(|\mathbf{G}|^2 - |\mathbf{Ksp} - \mathbf{Kinc}|^2) \,\mathrm{d}\mathbf{G}$ (3)

- θ_{inc} and λ are the incident angle and wavelength;
- factor1(**G**, θ_{inc} , ε_m , ε_d) is a factor that does not depend on the surface profile;
- the integral is on domain made of wave-vectors G matching the SP excitation condition;
- the **Power Spectral Density** (PSD) of the surface is defined as $PSD(G) = (L/2\pi)^2 |\zeta_G|^2$

From the knowledge of PSD(G) at the wave-vectors G matching (1) and (2) it is possible to find ΔRsp from (3)





Surface profiles with higher values of the PSD at the wave-vector **G** indicated by the circle have higher probability to support Surface -Plasmon modes.



SP Electric Field Enhancement

The Electric field associated to the SP charge oscillation is enhanced because of its spatial confinement close to the interface.



(4)

The enhancement ratio $(|E_{sp}|^2/|E_{inc}|^2)$ is given by ^[2]

$$|\mathsf{E}_{sp}|^2/|\mathsf{E}_{inc}|^2 = \cos(\theta_{inc}) \operatorname{factor2}(\lambda, \varepsilon_m, \varepsilon_d) \Delta \mathsf{R}_{sp}$$

- θ_{inc} and λ are the incident angle and wavelength;
- factor2(λ , ε_m , ε_d) is a factor that does depend only on the dielectric constants;
- ΔR_{sp} is the SP excitation probability defined in the previous slide

the Power Spectral Density is obtained by the AFM images

From the knowledge of PSD(**G**) at the wave-vectors **G** matching (1) and (2) it is possible to find ΔRsp from (3) and then $|E_{sp}|^2/|E_{inc}|^2$ from (4)

^[2] W. H. Weber, G. W. Ford, Optics Lett. 6, 122 (1981)



Excess Heat Samples after electrolysis



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ICCF-15, October 5-9, 2009, Rome

Field enhancement (PdH)

excess heat samples



O

20

40

incident angle

60

2

wavelength (m)

80





Field enhancement (PdH)

excess heat samples





ICCF-15, October 5-9, 2009, Rome

40

incident angle

60

2 80

wavelength (m)

0

20

What is the SP Driving Source?

suggestion:

Current fluctuations in the tunnel junction (MIM) [3]

- The metal/double layer/electrolyte interfaces as a MIM junction
- The power spectrum ($C(\omega)$) is due to time fluctuations

$$C(\omega) = \frac{eV}{2\pi R_0} \left(1 - \frac{\hbar\omega}{eV}\right).$$



^[3] R. W. Rendell and D. J. Scalapino, Phys. Rev. B 24, 3276 (1981)





- Pd foils can sustain excitonic modes
- Max electric field enhancement are order 10
- Current fluctuation at the double layer could drive plasmon excitations up to wavelenghts of fraction of micrometer



Effect of morphology on electro-chemical kinetics

- The metal/electrolyte interface is dynamical
- Electrochemical reactions take place at the metal/electrolyte interface
- Their kinetics is affected by surface morphology:
 - The surface morphology is modified by electrochemical reaction (i.e. Pd dissolution/deposition reactions)
 - Reaction rates involving impurities may also be affected by surface morphology





Change of the electrochemical kinetics of ions at planar or nano-spherical metal surfaces

$$\Delta G^{\dagger} = \frac{(\Delta G + \lambda_{\rm os})^2}{(4\lambda_{\rm os})}$$

(cfr. M. T. Splitzer, Electrochimica Acta <u>52</u> (2007) 2294-2301)



Fig. 2. (a) λ_{os} values calculated using Eq. (5) are shown for redox ions of radius 0.30, 0.60, and 0.90 nm (—) as they are stepped closer to a 1 nm semiconductor sphere. For each radius, the corresponding λ_{os} is also given for the ion at a planar semiconductor surface (---). (b) λ_{os} values calculated using Eq. (5) are shown for redox ions of radius 0.30, 0.60, and 0.90 nm (—) as they moved closer in steps to a 10.0 nm semiconductor sphere. For each radius, the corresponding λ_{os} is also given for the ion at a planar metal surface (---).

Interplay between electrochemical kinetics and surface morphology



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The surface morphology of Pd cathodes has been characterized by atomic force microscopy, after electrochemical D loading.

The Electric field enhancement due to plasmon excitation has been extimated on the basis of the AFM images and their Power Spectrum

The results indicate that field enhancement can occur on samples giving excess heat.



<u>Conclusions</u>

- The surface morphology play a role in changing the local e-m field at the cathode/electrolyte interface
- This mechanism could be accounted for when considering the electrochemical kinetics at the cathode, in particular in the case of nano-structured cathode surfaces
- Interplay between electrochemical kinetics and surface morphology has to be expected

Thank you for your attention !

